

NOTES:

1 MATERIAL:

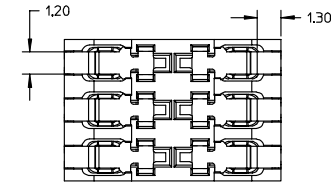
HOUSING: HIGH TEMPERATURE PLASTIC, GLASS FILLED, UL94V-0  
TERMINAL: COPPER ALLOY

2. PLATING:

SIM CARD CONTACT AREA PLATING: 30u" MIN GOLD OVER 50u" MIN NICKEL PLATING  
PCB SOLDERING AREA PLATING: 120u" MIN TIN-LEAD OVER 50u" MIN NICKEL PLATING  
VISIBLE AREA PLATING: GOLD FLASH OVER 50u" MIN NICKEL PLATING

3. PACKAGING: TAPE REEL

4. PRODUCT SPECIFICATION: PS-67687-001



EC NO: SH2003-0031 DRWN: SSUN 2003/04/07 CHK: SHUANG 2003/04/07 APPR: SHUANG 2003/04/07 REV DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	REVISE ON CAD ONLY	
	4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.2 ± --- 1 PLACE ± 0.25 ± --- ANGULAR ± 3 °	mm INCH	DIMENSION STYLE MM ONLY	DRAWN BY SSUN	DATE 2002/07/30	TITLE SIM CARD CONNECTOR SALES DRAWING	
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	APPROVED BY SAMHUANG	DATE 2002/07/30	CHECKED BY LZHAO	DATE 2002/07/30	MATERIAL NO. 676872001	DOCUMENT NO. SD-67687-201
						SHEET NO. 1 OF 1	B